

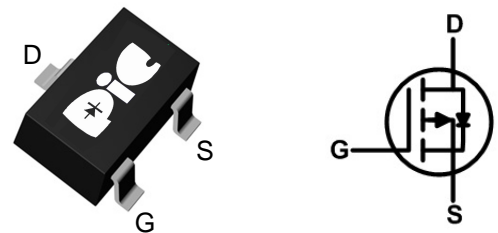
➤ General Description

This PAP3113N P-Channel enhancement mode power field effect transistor is the high density trench technology and this advanced technology can provide excellent Rds(On) performance and efficiency for power switching and load switching application., this device also comply with the RoHS and Green Product requirement with full function reliability approved.

➤ Feature

- Super Low Gate Charge
- Green Device Available
- Excellent CdV/dt effect decline
- Advanced high cell density Trench technology
- SOT-23 Package design

➤ SOT-23



➤ Application

- Load Switch
- Portable instrument
- MB / NB / 3C device

➤ Absolute Maximum Ratings

Parameter	Symbol	Rating		Units
		10s	Steady State	
Drain-Source Voltage	V_{DS}	-30		V
Gate-Source Voltage	V_{GS}	± 20		V
Continuous Drain Current, $V_{GS} @ -10V_1$	$I_D @ T_A=25^\circ C$	-5.5	-4.8	A
Continuous Drain Current, $V_{GS} @ -10V_1$	$I_D @ T_A=70^\circ C$	-4.3	-3.8	A
Pulsed Drain Current ²	I_{DM}	-24		A
Total Power Dissipation ³	$P_D @ T_A=25^\circ C$	1.32	1	W
Total Power Dissipation ³	$P_D @ T_A=70^\circ C$	0.84	0.64	W
Storage Temperature Range	T_{STG}	-55 to 150		$^\circ C$
Operating Junction Temperature Range	T_J	-55 to 150		$^\circ C$
Thermal Resistance Junction-Ambient ¹	$R_{\theta JA}$	125		$^\circ C/W$
Thermal Resistance Junction-Ambient ¹ (t ≤ 10s)	$R_{\theta JA}$	95		$^\circ C/W$
Thermal Resistance Junction-Case ¹	$R_{\theta JC}$	80		$^\circ C/W$

➤ Electrical Characteristics ($T_J=25^\circ C$ Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=-250\mu A$	-30	---	---	V
BV_{DSS} Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_J$	Reference to $25^\circ C, I_D=-1mA$	---	-0.022	---	$V/^\circ C$
Static Drain-Source On-Resistance ²	$R_{DS(ON)}$	$V_{GS}=-10V, I_D=-4A$	---	---	32	$m\Omega$
		$V_{GS}=-4.5V, I_D=-2A$	---	---	45	
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=-250\mu A$	-1.0	---	-2.5	V
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}$		---	4.6	---	$mV/^\circ C$
Drain-Source Leakage Current	I_{DSS}	$V_{DS}=-24V, V_{GS}=0V, T_J=25^\circ C$	---	---	1	μA
		$V_{DS}=-24V, V_{GS}=0V, T_J=55^\circ C$	---	---	5	
Gate-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$	---	---	± 100	nA
Forward Transconductance	g_{fs}	$V_{DS}=-5V, I_D=-4A$	---	15	---	S
Gate Resistance	R_g	$V_{DS}=0V, V_{GS}=0V, f=1MHz$	---	13	---	Ω
Total Gate Charge (-4.5V)	Q_g	$V_{DS}=-15V, V_{GS}=-4.5V, I_D=-4A$	---	9.7	---	nC
Gate-Source Charge	Q_{gs}		---	2.5	---	
Gate-Drain Charge	Q_{gd}		---	3	---	
Turn-On Delay Time	$T_{d(on)}$	$V_{DD}=-15V, V_{GS}=-10V, R_G=3.3\Omega, I_D=-4A$	---	16.4	---	ns
Rise Time	T_r		---	20.2	---	
Turn-Off Delay Time	$T_{d(off)}$		---	55	---	
Fall Time	T_f		---	10	---	
Input Capacitance	C_{iss}	$V_{DS}=-15V, V_{GS}=0V, f=1MHz$	---	942	---	pF
Output Capacitance	C_{oss}		---	165	---	
Reverse Transfer Capacitance	C_{rss}		---	137	---	

➤ Diode Characteristics

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Continuous Source Current ^{1,4}	I_S	$V_G=V_D=0V, \text{Force Current}$	---	---	-4.8	A
Pulsed Source Current ^{2,4}	I_{SM}		---	---	-24	A
Diode Forward Voltage ²	V_{SD}	$V_{GS}=0V, I_S=-1A, T_J=25^\circ C$	---	---	-1.2	V
Reverse Recovery Time	t_{rr}	$I_F=-4A, di/dt=100A/\mu s, T_J=25^\circ C$	---	18.3	---	nS
Reverse Recovery Charge	Q_{rr}		---	7.2	---	nC

Note :

1. Pulse width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$
3. Ensure that the channel temperature does not exceed $150^\circ C$.
4. The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.

➤ Typical Characteristics

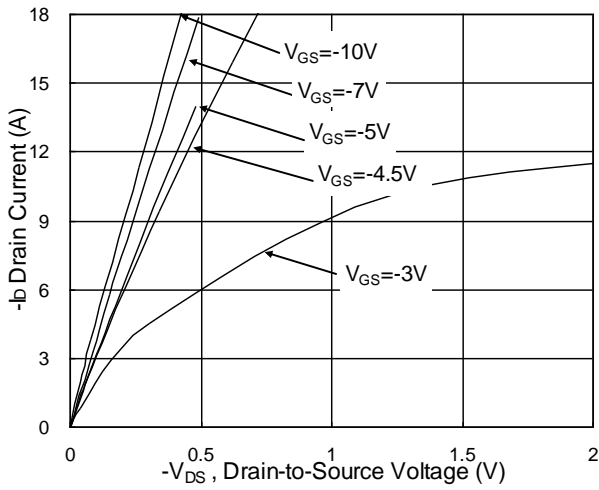


Fig.1 Typical Output Characteristics

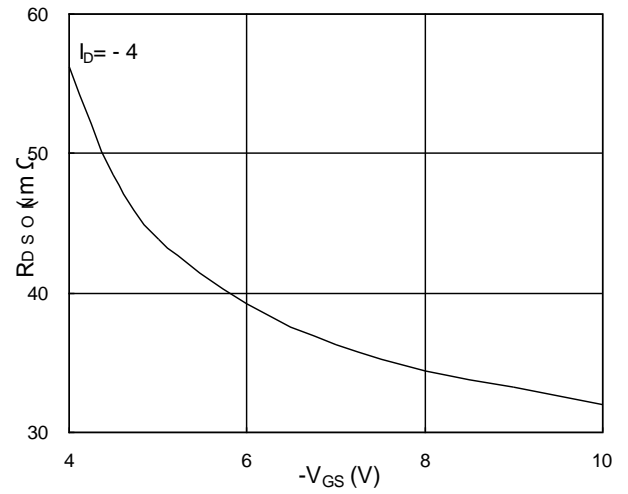


Fig.2 On-Resistance v.s Gate-Source

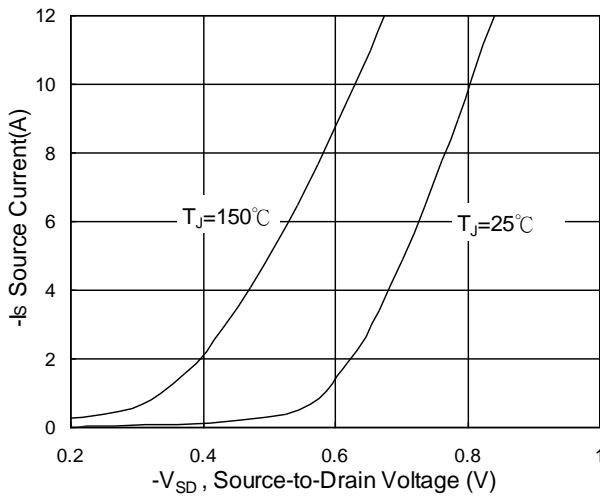


Fig.3 Forward Characteristics of Reverse

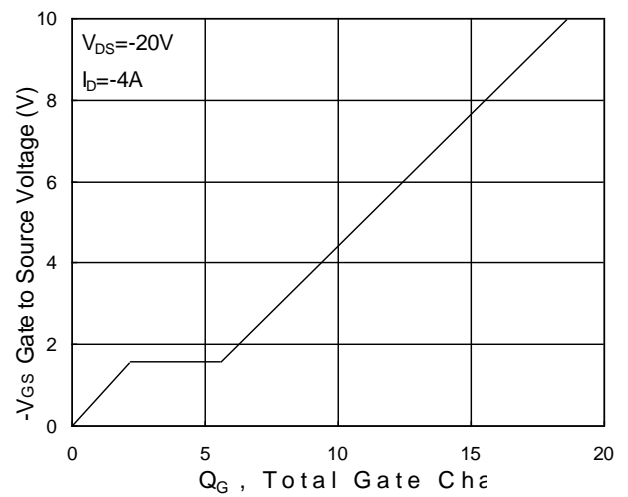


Fig.4 Gate-Charge Characteristics

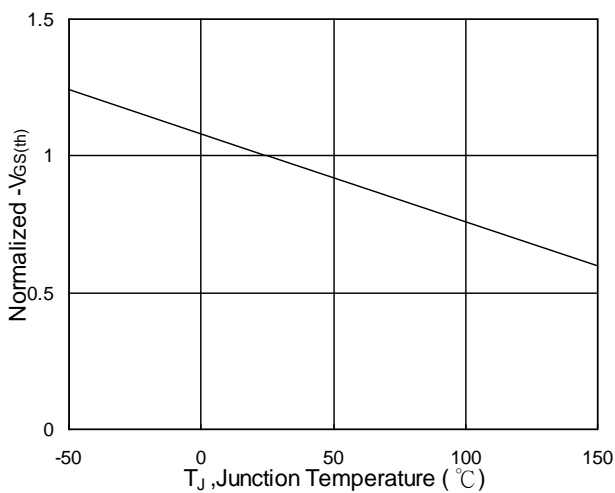


Fig.5 Normalized $V_{GS(th)}$ v.s T_J

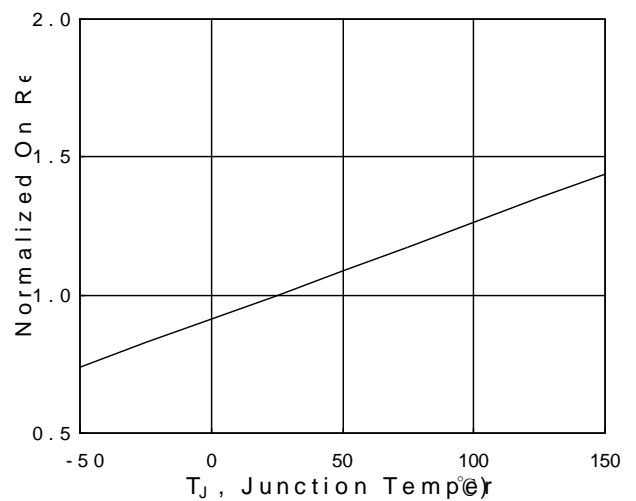


Fig.6 Normalized $R_{DS(on)}$ v.s T_J

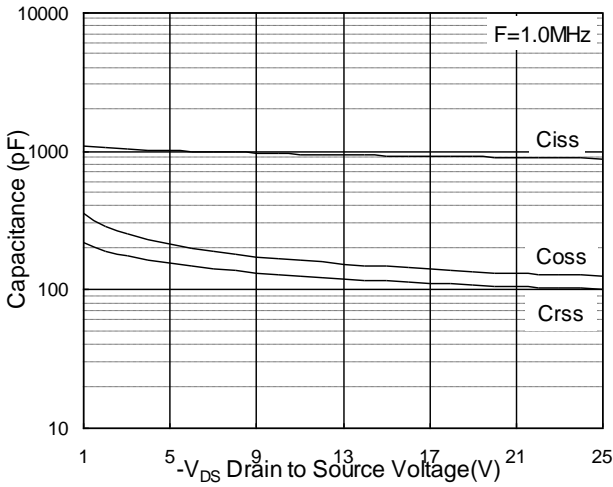


Fig.7 Capacitance

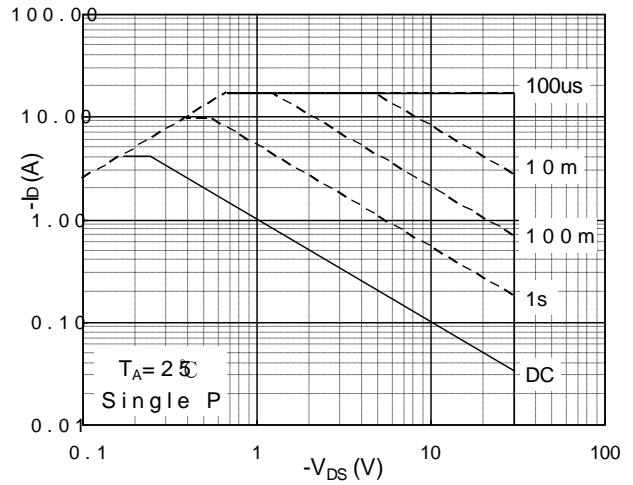


Fig.8 Safe Operating Area

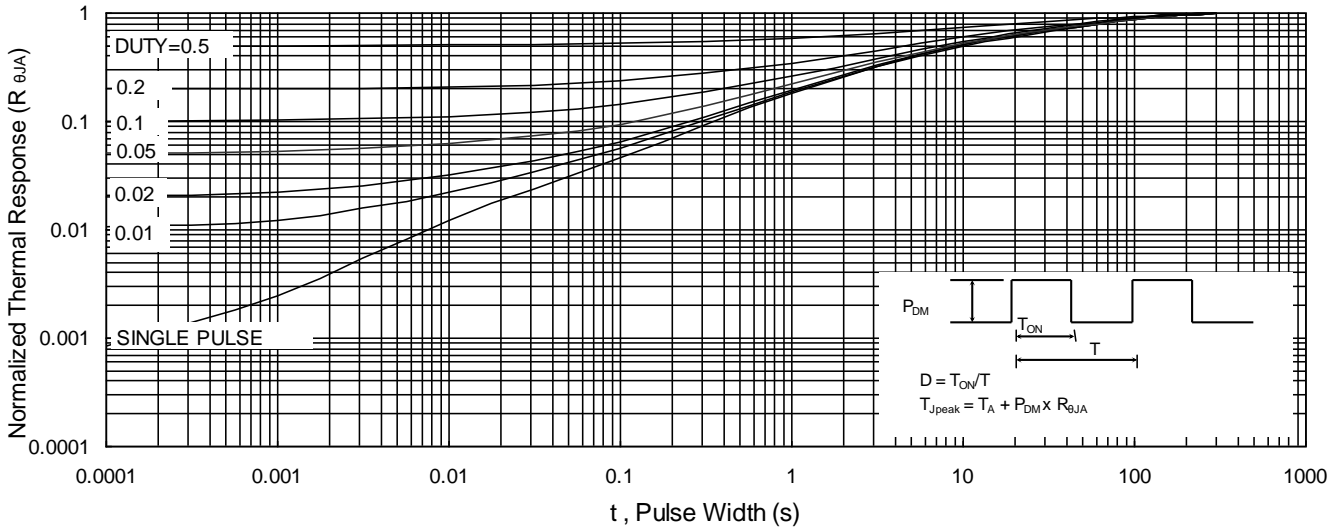


Fig.9 Normalized Maximum Transient Thermal Impedance

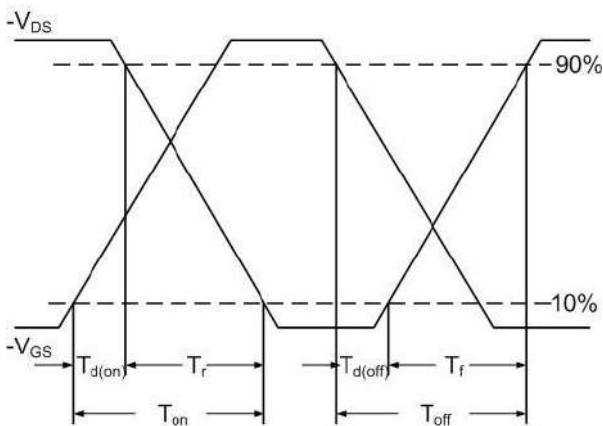


Fig.10 Switching Time Waveform

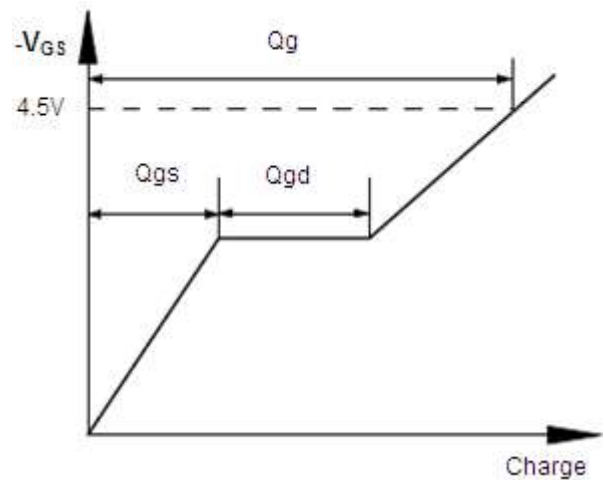
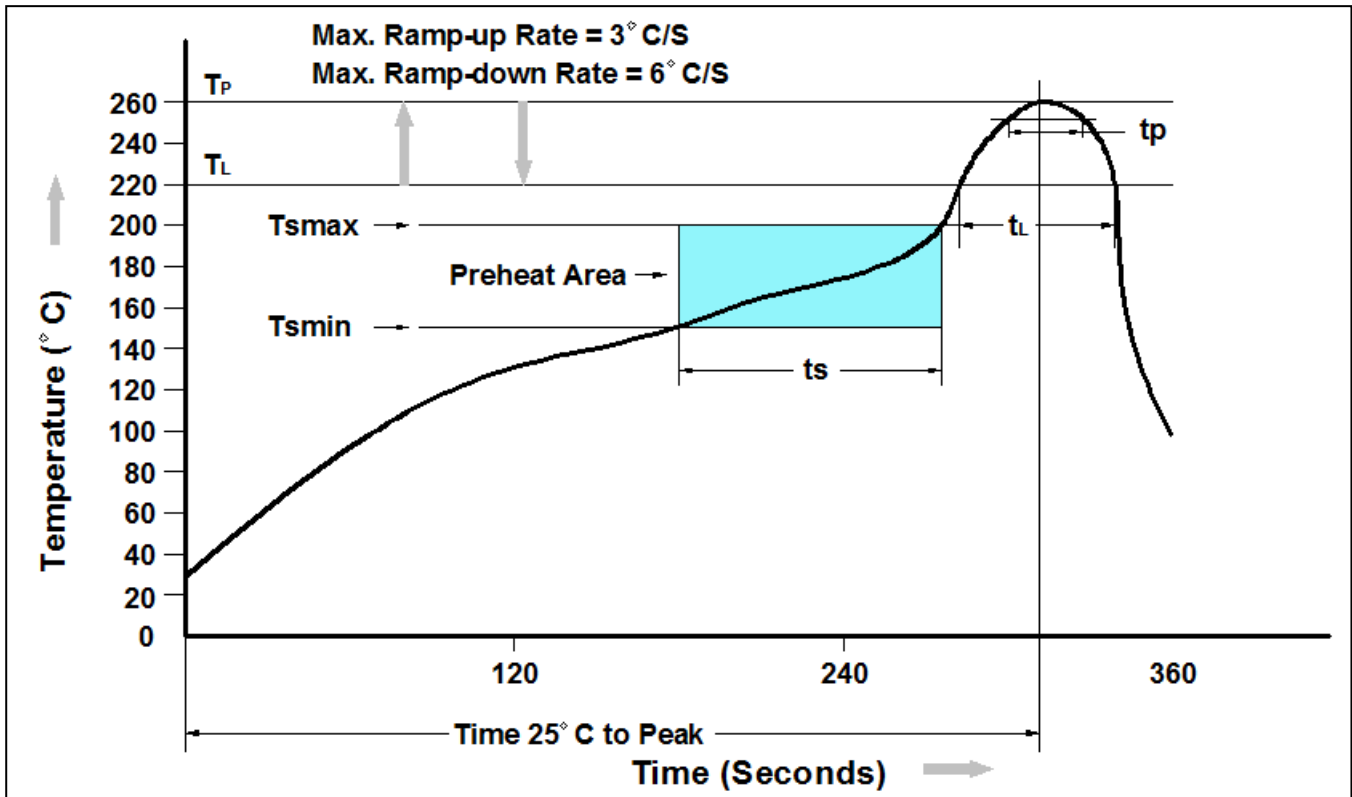


Fig.11 Gate Charge Waveform

➤ Recommand IR Reflow Soldering Thermal Profile

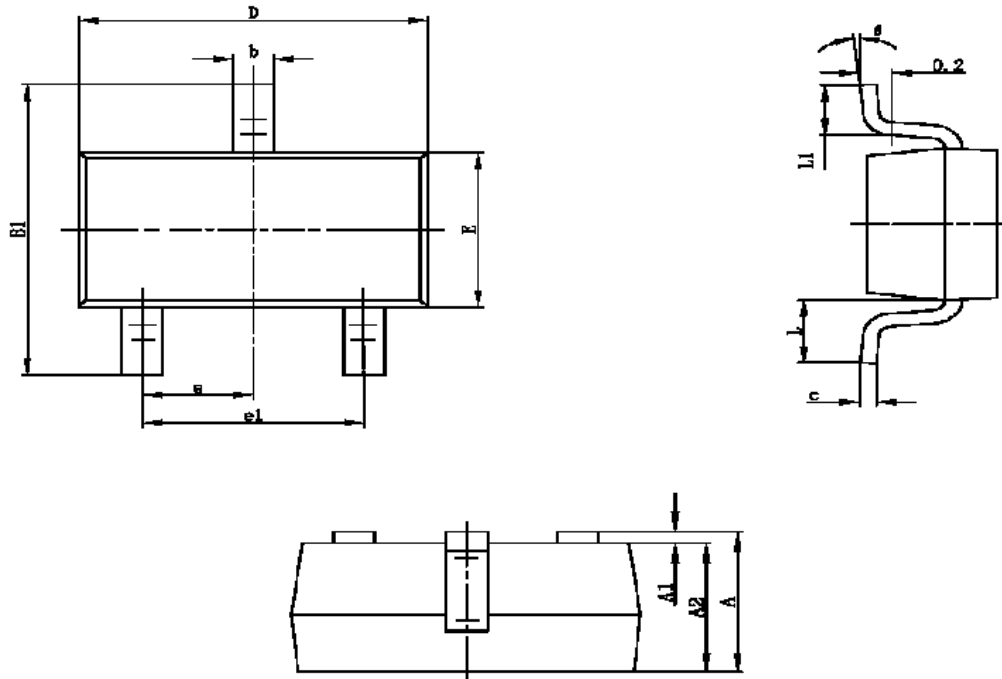


Profile Feature	Pb-Free Assembly Profile
Temperature Min. (T _{smin})	150°C
Temperature Max. (T _{smax})	200°C
Time (t _s) from (T _{smin} to T _{smax})	60-120 seconds
Average Ramp-up Rate (t _L to t _P)	3°C/second max.
Liquidous Temperature (T _L)	217°C
Time (t _L) Maintained Above (T _L)	60 – 150 seconds
Peak Temperature	260°C +0°C / -5°C
Time (t _P) within 5°C of actual Peak Temperature	30 seconds
Ramp-down Rate (T _P to T _L)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.

➤ Ordering Information

Part Number	Description	Quantity
PAP3113N	SOT-23 Reel	3000 pcs

➤ Package Information (SOT-23)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.400	0.012	0.016
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.700REF		0.028REF	
L1	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°

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